

3A, 50V - 1000V Surface Mount Fast Recovery Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Fast switching for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 0.21 g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	3	A
V_{RRM}	50 - 1000	V
I_{FSM}	100	A
T_{JMAX}	150	°C
Package	DO-214AB (SMC)	



DO-214AB (SMC)

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)									
PARAMETER	SYMBOL	RS 3A-K	RS 3B-K	RS 3D-K	RS 3G-K	RS 3J-K	RS 3K-K	RS 3M-K	UNIT
Marking code on the device		RS3A	RS3B	RS3D	RS3G	RS3J	RS3K	RS3M	
Repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Forward current	I_F	3							A
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I_{FSM}	100							A
Junction temperature	T_J	- 55 to +150							°C
Storage temperature	T_{STG}	- 55 to +150							°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP.	UNIT
Junction-to-lead thermal resistance per diode	$R_{\theta JL}$	10	$^{\circ}C/W$
Junction-to-ambient thermal resistance per diode	$R_{\theta JA}$	56	$^{\circ}C/W$
Junction-to-case thermal resistance per diode	$R_{\theta JC}$	11	$^{\circ}C/W$

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	TYP.	MAX.	UNIT	
Forward voltage per diode ⁽¹⁾	$I_F = 1.5A, T_J = 25^{\circ}C$	V_F	0.99	-	V	
	$I_F = 3.0A, T_J = 25^{\circ}C$		1.10	1.30	V	
	$I_F = 1.5A, T_J = 125^{\circ}C$		0.81	-	V	
	$I_F = 3.0A, T_J = 125^{\circ}C$		0.91	1.05	V	
Reverse current @ rated V_R per diode ⁽²⁾	$T_J = 25^{\circ}C$	I_R	-	10	μA	
	$T_J = 125^{\circ}C$		-	250	μA	
Junction capacitance	1 MHz, $V_R = 4.0V$	C_J	24	-	pF	
Reverse recovery time	RS3A-K RS3B-K RS3D-K RS3G-K	$I_F = 0.5A, I_R = 1.0A$ $I_{RR} = 0.25A$	t_{rr}	-	150	ns
	RS3J-K			-	250	ns
	RS3K-K RS3M-K			-	500	ns

Notes:

1. Pulse test with $PW = 0.3$ ms
2. Pulse test with $PW = 30$ ms

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
RS3A-K R7G	SMC	850 / 7" Plastic reel
RS3A-K M6G	SMC	3,000 / 13" Plastic reel
RS3B-K R7G	SMC	850 / 7" Plastic reel
RS3B-K M6G	SMC	3,000 / 13" Plastic reel
RS3D-K R7G	SMC	850 / 7" Plastic reel
RS3D-K M6G	SMC	3,000 / 13" Plastic reel
RS3G-K R7G	SMC	850 / 7" Plastic reel
RS3G-K M6G	SMC	3,000 / 13" Plastic reel
RS3J-K R7G	SMC	850 / 7" Plastic reel
RS3J-K M6G	SMC	3,000 / 13" Plastic reel
RS3K-K R7G	SMC	850 / 7" Plastic reel
RS3K-K M6G	SMC	3,000 / 13" Plastic reel
RS3M-K R7G	SMC	850 / 7" Plastic reel
RS3M-K M6G	SMC	3,000 / 13" Plastic reel

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

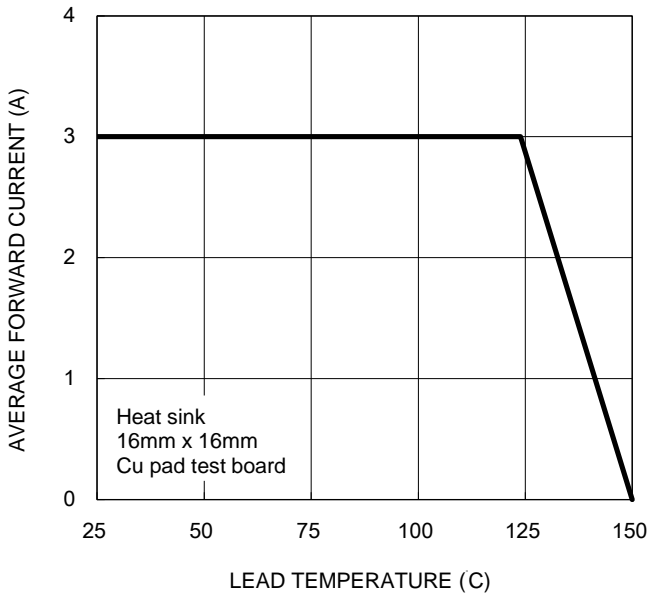


Fig.2 Typical Junction Capacitance

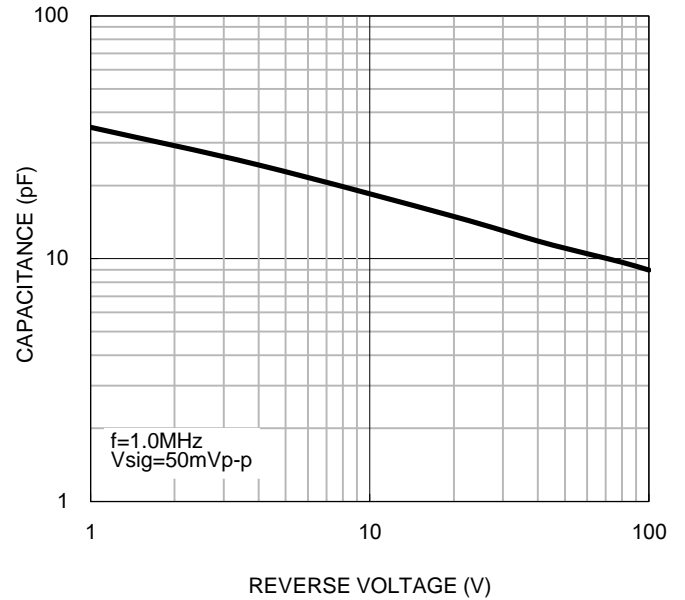


Fig.3 Typical Reverse Characteristics

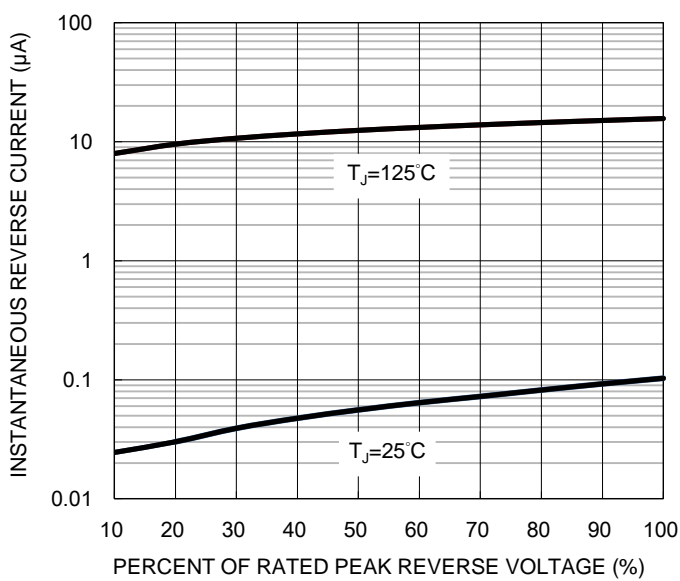
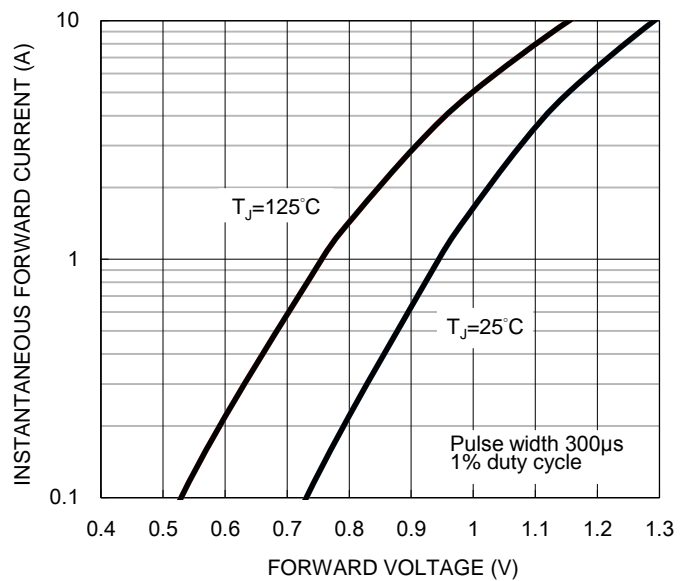


Fig.4 Typical Forward Characteristics



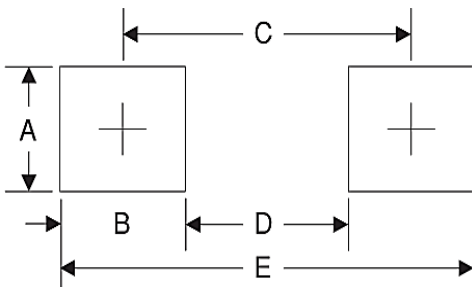
PACKAGE OUTLINE DIMENSIONS

DO-214AB (SMC)



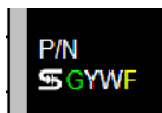
DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	2.90	3.20	0.114	0.126
B	6.60	7.11	0.260	0.280
C	5.59	6.22	0.220	0.245
D	2.00	2.62	0.079	0.103
E	1.00	1.60	0.039	0.063
F	7.75	8.13	0.305	0.320
G	0.10	0.20	0.004	0.008
H	0.15	0.31	0.006	0.012

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
B	2.50	0.098
C	6.80	0.268
D	4.40	0.173
E	9.40	0.370

MARKING DIAGRAM



- P/N =Marking Code
- G =Green Compound
- YW =Date Code
- F =Factory Code

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